onsemi

Hybrid IGBT, 50 A, 650 V

AFGHL50T65SQDC

Using the novel field stop 4th generation IGBT technology and the 1.5th generation SiC Schottky Diode technology, AFGHL50T65SQDC offers the optimum performance with both low conduction and switching losses for high efficiency operations in various applications, especially totem pole bridgeless PFC and Inverter.

Features

- AEC-Q101 Qualified
- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(Sat)} = 1.6 V (Typ.) @I_C = 50 A
- Fast Switching
- Tighten Parameter Distribution
- No Reverse Recovery/No Forward Recovery

Typical Applications

- Automotive
- On & Off Board Chargers
- DC-DC Converters
- PFC
- Industrial Inverter

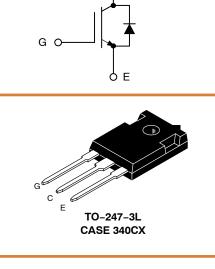
MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Collector to Emitter Voltage		V _{CES}	650	V
Gate to Emitter Voltage Transient Gate to Emitter Volt	age	V _{GES}	±20 ±30	V
Collector Current	@T _C = 25°C @T _C = 100°C	Ι _C	100 50	А
Pulsed Collector Current (Not	e 1)	I _{LM}	200	А
Pulsed Collector Current (Not	e 2)	I _{CM}	200	А
Diode Forward Current	@T _C = 25°C @T _C = 100°C	١ _F	40 20	A
Pulsed Diode Maximum Forward Current		I _{FM}	200	А
Maximum Power Dissipation	@T _C = 25°C @T _C = 100°C	P _D	238 119	W
Operating Junction / Storage Temperature Range	9	T _J , T _{STG}	±55 to +175	°C
Maximum Lead Temp. for Sol Purposes, 1/8" from case for		ΤL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. V_{CC} = 400 V, V_{GE} = 15 V, I_{C} = 200 A, R_{G} = 26 $\Omega,$ Inductive Load, 100% Tested.

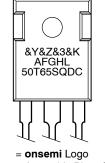
2. Repetitive Rating: pulse width limited by max. Junction temperature.



50 A, 650 V V_{CESat} = 1.6 V (Typ.)

Q C

MARKING DIAGRAM



&Y	= onsemi Logo
&Z	= Assembly Plant Code
&3	= 3-Digit Data Code
&K	= 2-Digit Lot Traceability Code
AFGHL50T65S	QDC = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping
AFGHL50T65SQDC	TO-247-3L	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ extsf{ heta}JC}$	0.63	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ hetaJC}$	1.55	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
OFF CHARACTERISTICS					•	
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 V,$ $I_C = 1 mA$	BV _{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	$\frac{\Delta \text{BV}_{\text{CES}}}{\Delta \text{T}_{\text{J}}}$	_	0.6	-	V/°C
Collector-emitter cut-off current, gate-emitter short-circuited	V _{GE} = 0 V, V _{CE} = 650 V	I _{CES}	-	-	250	μΑ
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 V,$ $V_{CE} = 0 V$	I _{GES}	-	-	±400	nA
ON CHARACTERISTICS						
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 50 \text{ mA}$	V _{GE(th)}	3.4	4.9	6.4	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 50 A V_{GE} = 15 V, I _C = 50 A, T_{J} = 175°C	V _{CE(sat)}	-	1.6 1.9	2.1 -	V
DYNAMIC CHARACTERISTICS				•	•	
Input capacitance	V _{CE} = 30 V,	C _{ies}	_	3098	-	pF
Output capacitance	V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	265	-	
Reverse transfer capacitance		C _{res}	-	9	-	
Gate charge total	V _{CE} = 400 V,	Qg	_	94	-	nC
Gate to emitter charge	I _C = 50 V, V _{GE} = 15 V	Q _{ge}	_	18	-	
Gate to collector charge		Q _{gc}	_	23	-	
SWITCHING CHARACTERISTICS						
Turn-on delay time	$T_J = 25^{\circ}C$	t _{d(on)}	_	17.6	-	ns
Rise time	VCC = 400 V, IC = 12.5 A	t _r	_	6.4	-	
Turn-off delay time	R _G = 4.7 Ω	t _{d(off)}	_	94.4	-	
Fall time	V _{GE} = 15 V Inductive Load	t _f	_	14.4	-	
Turn-on switching loss		E _{on}	_	131	-	μJ
Turn-off switching loss		E _{off}	_	96	-	
Total switching loss		E _{ts}	_	227	-	
Turn-on delay time	$T_J = 25^{\circ}C$	t _{d(on)}	_	19.2	-	ns
Rise time	VCC = 400 V, IC = 25 A R _G = 4.7 Ω V _{GE} = 15 V	t _r	-	11.2	-	
Turn-off delay time		td _(off)	-	89.6	-	
Fall time	Inductive Load	t _f	-	6.4	-	
Turn-on switching loss	1	Eon	-	311	-	μJ
Turn-off switching loss	1	Eoff	-	141	-	
Total switching loss	1	Ets	_	452	-	1



ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Total Capacitance

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
SWITCHING CHARACTERISTICS						
Turn-on delay time	T _J = 175°C	t _{d(on)}	_	16	-	ns
Rise time	VCC = 400 V, IC = 12.5 A	t _r	_	8	-	
Turn-off delay time	R _G = 4.7 Ω V _{GE} = 15 V	t _{d(off)}	_	107.2	-	
Fall time	Inductive Load	t _f	-	53.6	-	
Turn-on switching loss		E _{on}	-	157	-	μJ
Turn-off switching loss		E _{off}	-	193	-	
Total switching loss		E _{ts}	-	350	-	
Turn-on delay time	$T_{J} = 175^{\circ}C$	t _{d(on)}	-	17.6	-	ns
Rise time	VCC = 400 V, IC = 25 A	t _r	-	14.4	-	
Turn-off delay time	R _G = 4.7 Ω V _{GE} = 15 V	t _{d(off)}	-	99.2	-	
Fall time	Inductive Load	t _f	-	9.6	-	
Turn-on switching loss		E _{on}	-	350	-	μJ
Turn-off switching loss		E _{off}	-	328	-	
Total switching loss		E _{ts}	_	678	-	
DIODE CHARACTERISTICS						
Forward voltage	I _F = 20 A I _F = 20 A, T _J = 175°C	V _F	-	1.45 1.83	1.75	V

 V_R = 600 V, f = 1 MHz
 99

 Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

V_R = 400 V, f = 1 MHz

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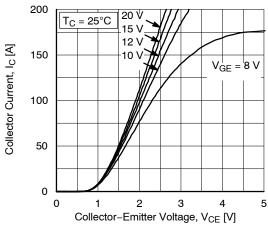
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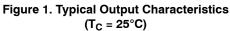


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TYPICAL CHARACTERISTICS





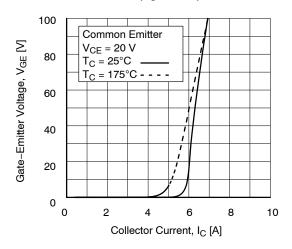


Figure 3. Transfer Characteristics

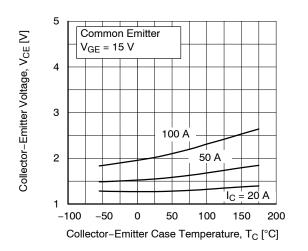


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

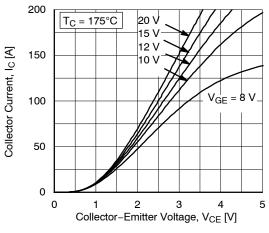
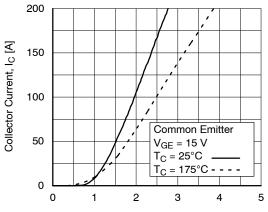
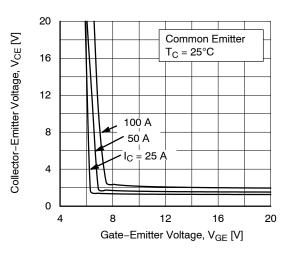


Figure 2. Typical Output Characteristics (T_C = 175°C)



Collector-Emitter Voltage, V_{CE} [V]

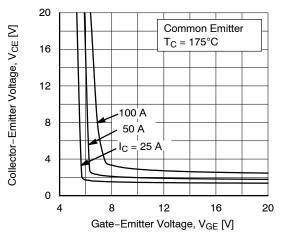
Figure 4. Typical Saturation Voltage Characteristics



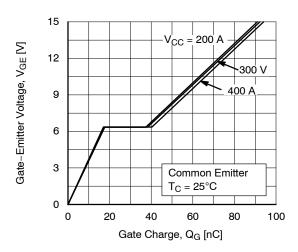




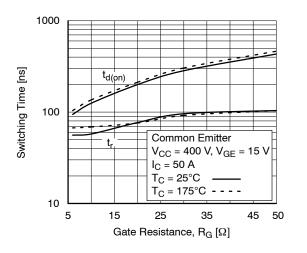
TYPICAL CHARACTERISTICS (continued)

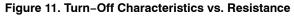


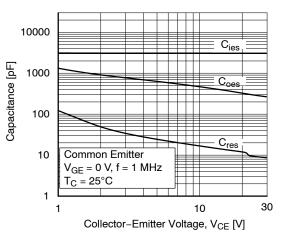


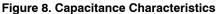












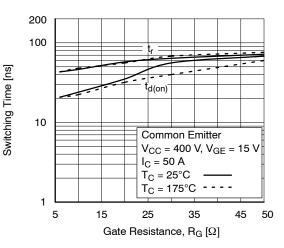


Figure 10. Turn-on Characteristics vs. Gate Resistance

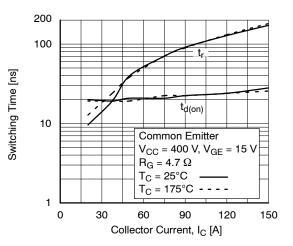
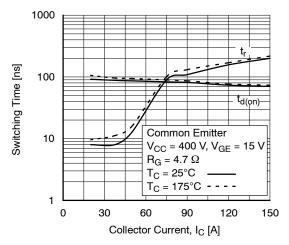
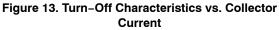


Figure 12. Turn-On Characteristics vs. Collector Current



TYPICAL CHARACTERISTICS (continued)





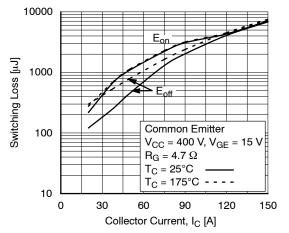


Figure 15. Switching Loss vs. Collector Current

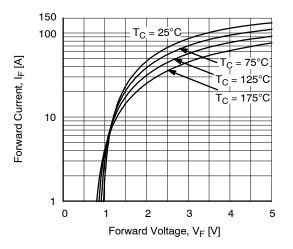


Figure 17. (Diode) Forward Characteristics vs. (Normal I–V)

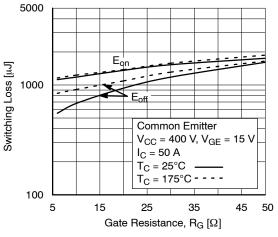


Figure 14. Switching Loss vs. Gate Resistance

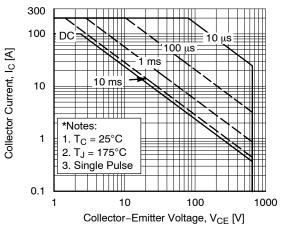
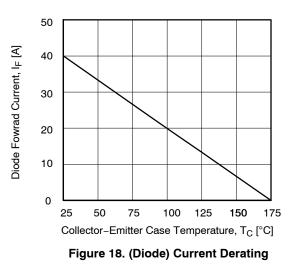
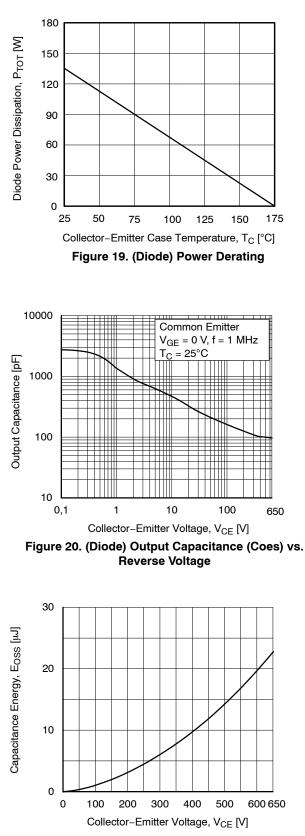


Figure 16. SOA Characteristics (FBSOA)





TYPICAL CHARACTERISTICS (continued)









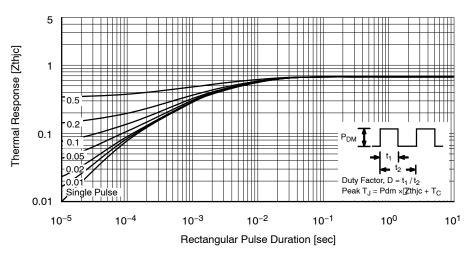


Figure 22. Transient Thermal Impedance of IGBT

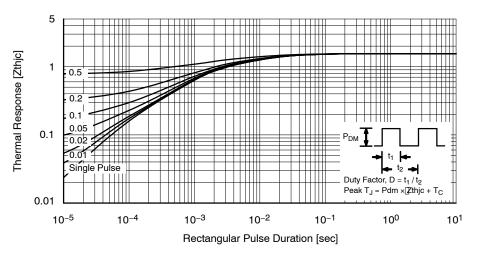
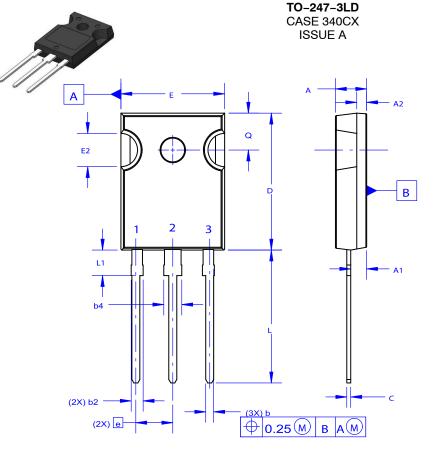


Figure 23. Transient Thermal Impedance of Diode







NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

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GENERIC **MARKING DIAGRAM*** Х



XXXXX	= Specific Device Code
Α	= Assembly Location

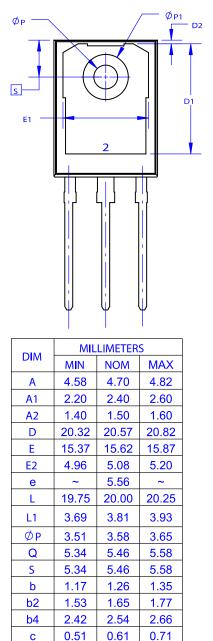
- = Assembly Location
- = Year
- ww = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

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DATE 06 JUL 2020



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